

Purolite™ A400PL/4823

ポリスチレン系 ゲル, I型強塩基性ア
ニオン交換樹脂ゲル, 塩素形, 低TOC,
混床樹脂グレード

PRINCIPAL APPLICATIONS

- 半導体 - 電子産業
- 脱塩 - 超純水
- 混床樹脂アニオン交換樹脂成分
- Primary Demineralization

ADVANTAGES

- 低TOCタイプ樹脂
- 高い分離性

SYSTEMS

- 混床樹脂脱塩装置

TYPICAL PACKAGING

- 1 ft³ Sack
- 25 L Sack
- 5 ft³ Drum (Fiber)
- 1 m³ Supersack
- 42 ft³ Supersack

TYPICAL PHYSICAL & CHEMICAL CHARACTERISTICS:

総交換容量 (最小)	1.3 eq/l (28.4 Kgr/ft³) (Cl⁻)
水分含有率	48 - 54 eq/l (Cl⁻)
粒径範囲	425 - 1000 µm
< 425 µm (max.)	2 %
可逆的膨張, Cl⁻ → OH⁻ (最大)	30 %
比重	1.08
見かけ密度 (概算)	680 - 710 g/L (42.5 - 44.4 lb/ft³)
温度制限	100 °C (212.0 °F) (Cl⁻)
温度制限	60 °C (140.0 °F) (OH⁻ 形)

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